







Course Participation **CERTIFICATE**

This to certify that

Dr. Ashwini Aggarwal

of MRIIRS/ Applied Materials has taken the

Professional Development online Course from September 23 to December 16, 2023

"INTRODUCTION TO DEVICE AND SYSTEM PACKAGING"

by Prof Rao Tummala and the Authors of Text book Fundamentals of Device and Systems Packaging, McGraw-Hill, NY 2019

Prof. Rao Tummala Creator of the Book and the Course Father of Modern Packaging Advisor, India Semiconductor Mission (ISM) Emeritus Professor, Georgia Institute of Technology

Kangoplks

Prof. V. Ramgopal Rao Vice Chancellor, BITS Pilani Course offered and Managed by BITS Pilani Team

